

(12)

United States Design Patent

Wu

(10)

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(54) **BONE CONDUCTION HEADSET**

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(**) Term: **15 Years**

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(52) **U.S. Cl.**
USPC **D14/205**

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381/380–381, 374
CPC H04R 1/10; H04R 1/1066; H04R 1/1016;
H04R 1/02; H04R 25/00; H04R 1/105;
H04R 5/033; H04R 5/0335; H04R
1/1041; H04R 1/1058; H04R 1/1075;
H04R 1/1033; H04R 1/1008
See application file for complete search history.

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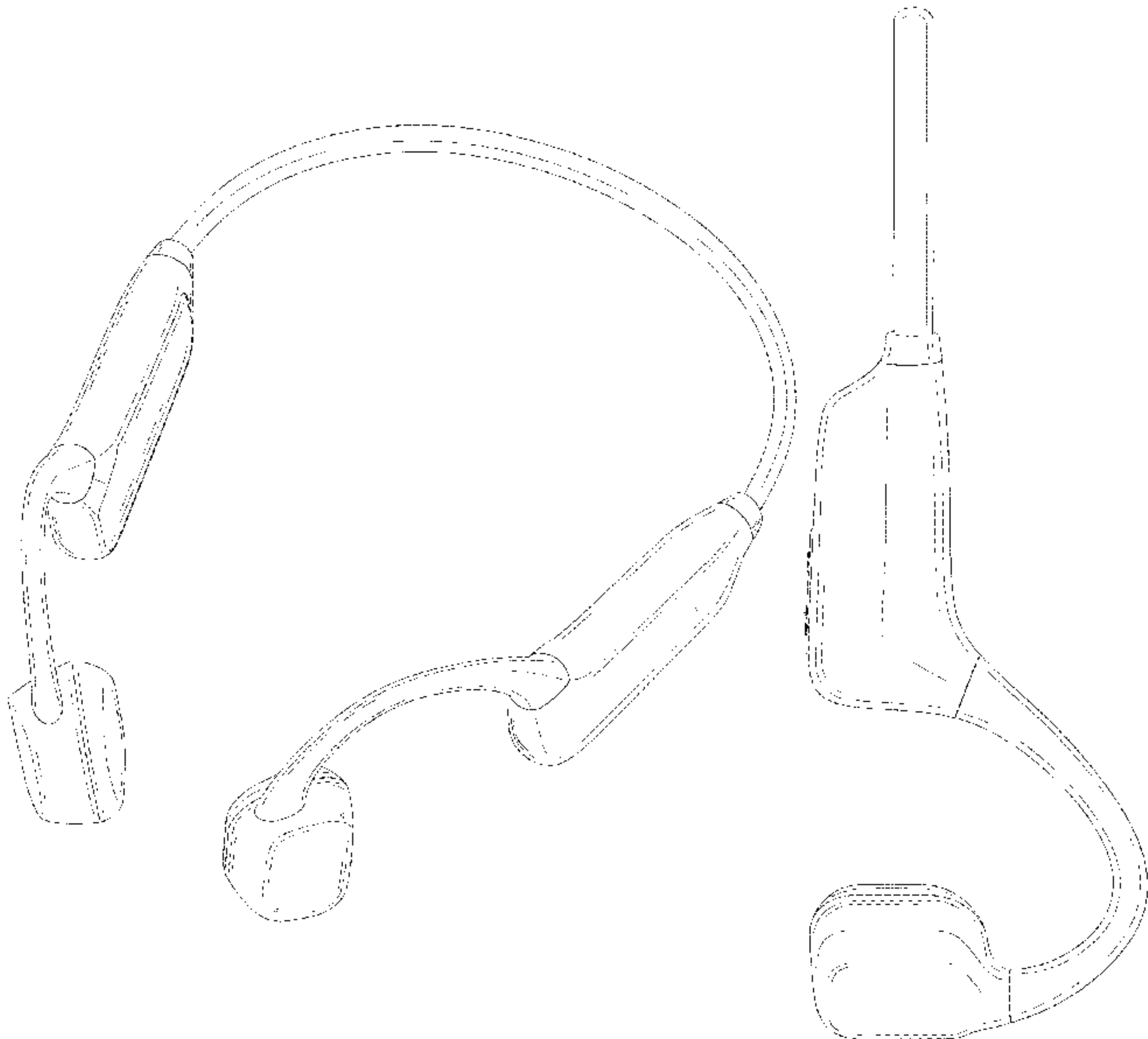
(57) **CLAIM**

The ornamental design for a bone conduction headset, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a bone conduction headset, showing my new design;
FIG. 2 is a front view thereof;
FIG. 3 is a rear view thereof;
FIG. 4 is a left side view thereof;
FIG. 5 is a right side view thereof;
FIG. 6 is a top plan view thereof; and,
FIG. 7 is a bottom plan view thereof.
The broken lines depict portions of the bone conduction headset that forms no part of the claimed design

1 Claim, 7 Drawing Sheets



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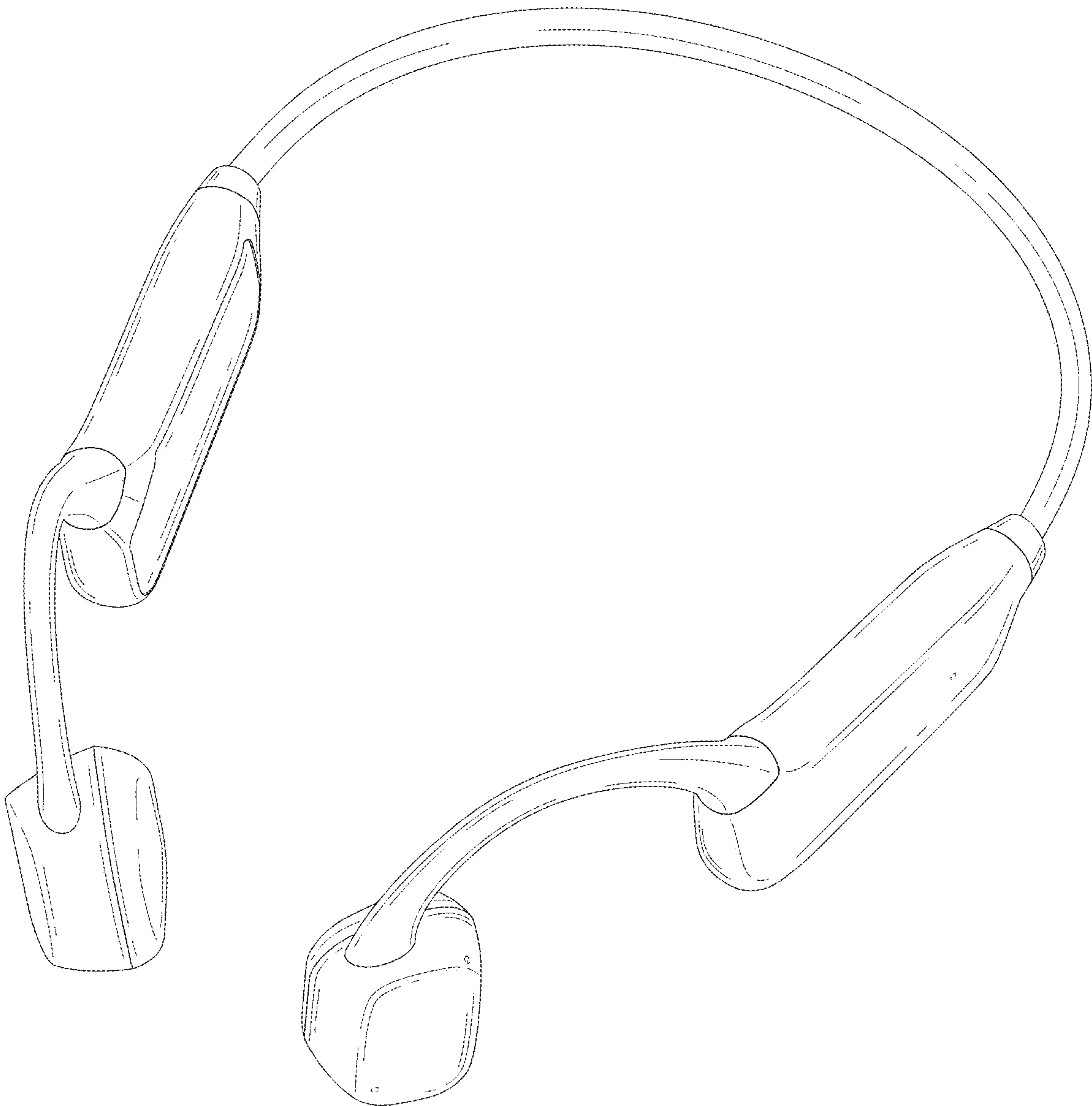


FIG. 1



FIG. 2



FIG. 3

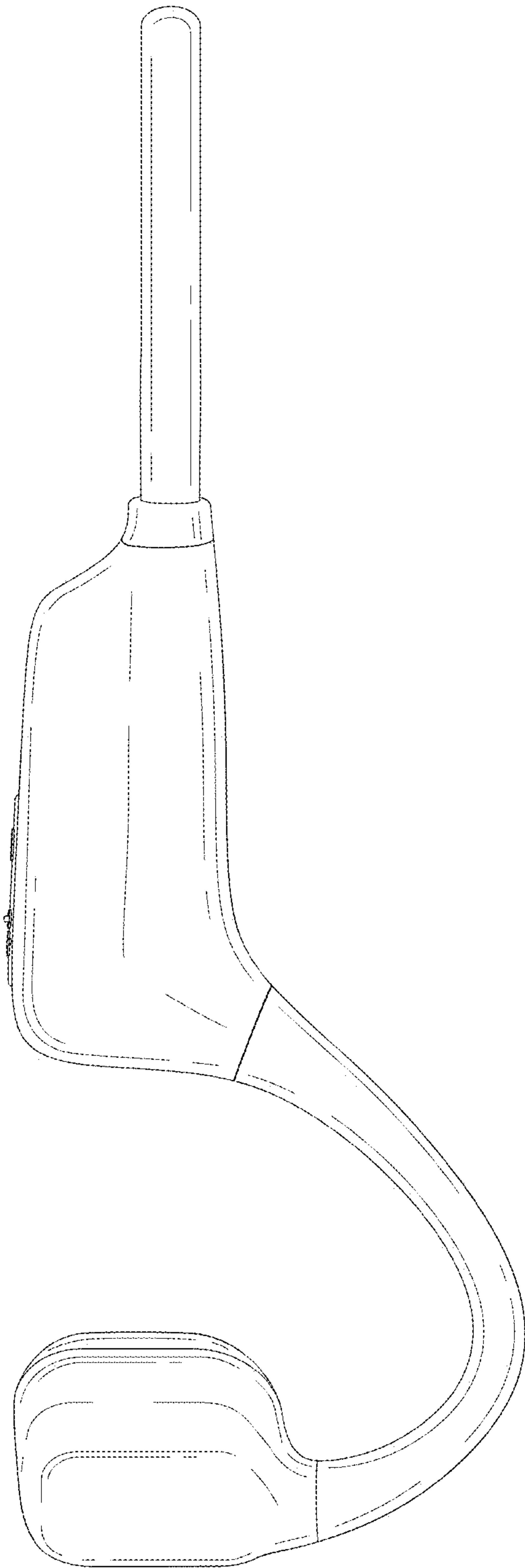


FIG. 4

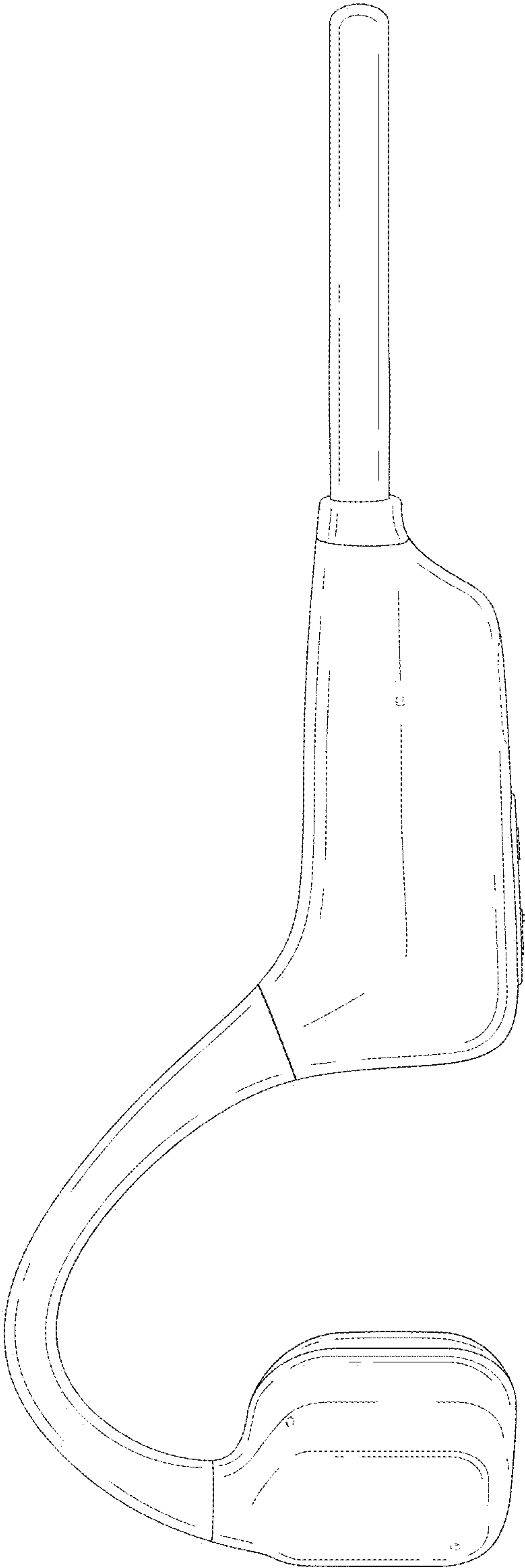


FIG. 5

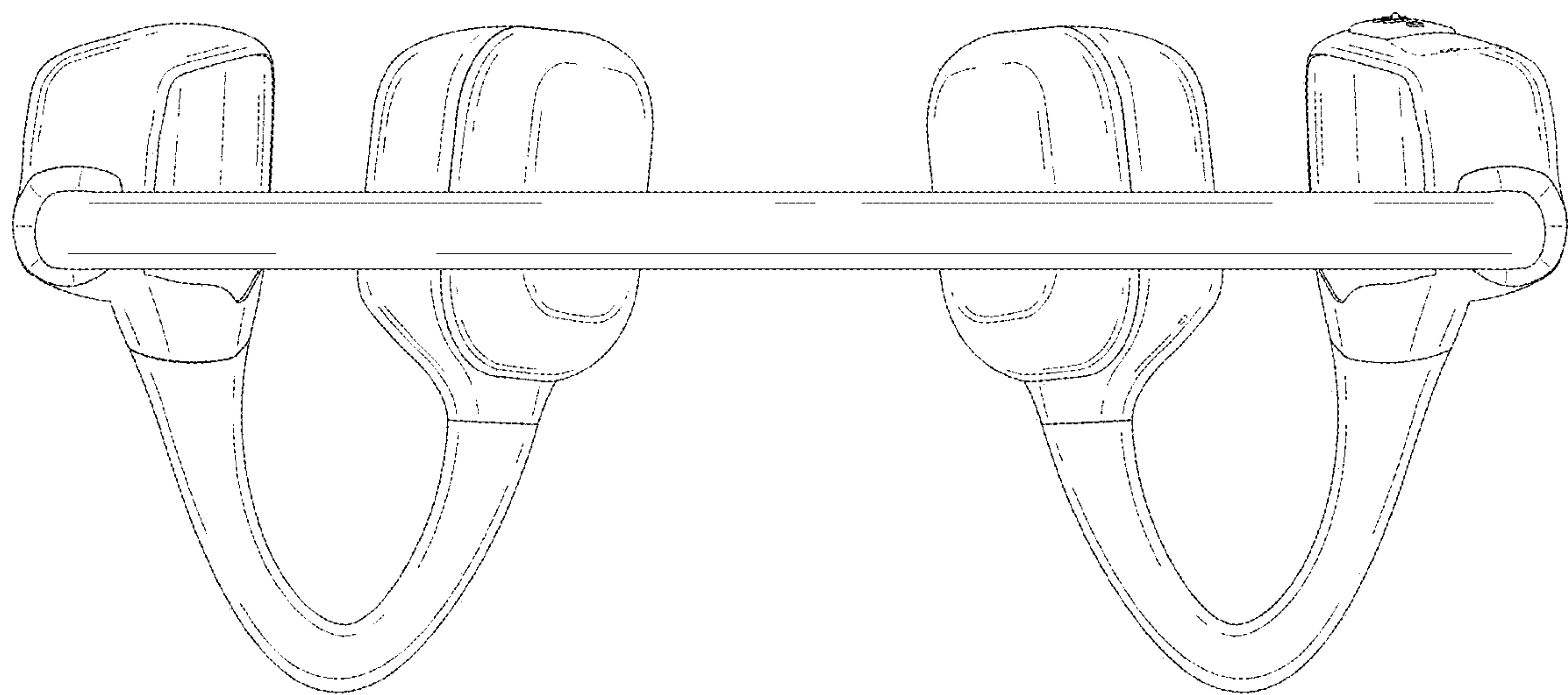


FIG. 6

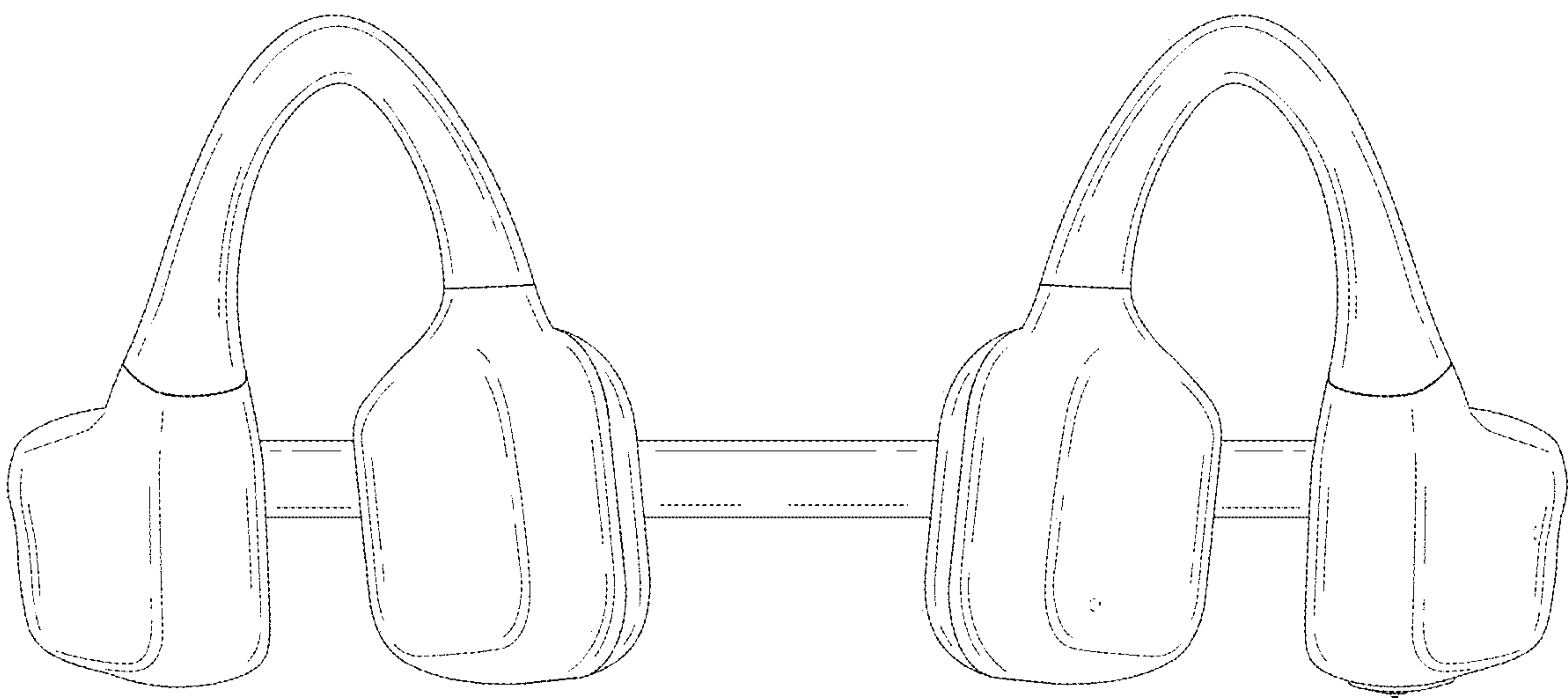


FIG. 7